

600V / 300A 2 in one-package

■ Features

- VCE(sat) classified for easy parallel connection
- High speed switching
- Voltage drive
- Low inductance module structure

**■ Applications**

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines

■ Maximum ratings and characteristics**● Absolute maximum ratings (at $T_c=25^\circ\text{C}$ unless otherwise specified)**

Item	Symbol	Rating	Unit
Collector-Emitter voltage	V_{CES}	600	V
Gate-Emitter voltage	V_{GES}	± 20	V
Collector current	Continuous	I_c	A
	1ms	I_c pulse	600
		- I_c	300
1ms		- I_c pulse	600
			A
Max. power dissipation	P_c	1100	W
Operating temperature	T_j	+150	$^\circ\text{C}$
Storage temperature	T_{stg}	-40 to +125	$^\circ\text{C}$
Isolation voltage	V_{is}	AC 2500 (1min.)	V
Screw torque	Mounting *1	3.5	N·m
	Terminals *1	3.5	N·m

*1 : Recommendable value : 2.5 to 3.5 N·m(M5)

● Electrical characteristics (at $T_j=25^\circ\text{C}$ unless otherwise specified)

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	I_{CES}	—	—	2.0	$V_{GE}=0\text{V}$, $V_{CE}=600\text{V}$	mA
Gate-Emitter leakage current	I_{GES}	—	—	30	$V_{CE}=0\text{V}$, $V_{GE}=\pm 20\text{V}$	μA
Gate-Emitter threshold voltage	$V_{GE(\text{th})}$	4.5	—	7.5	$V_{CE}=20\text{V}$, $I_c=300\text{mA}$	V
Collector-Emitter saturation voltage	$V_{CE(\text{sat})}$	—	—	2.8	$V_{GE}=15\text{V}$, $I_c=300\text{A}$	V
Input capacitance	C_{ies}	—	19800	—	$V_{GE}=0\text{V}$ $V_{CE}=10\text{V}$ $f=1\text{MHz}$	pF
Output capacitance	C_{oes}	—	4400	—		
Reverse transfer capacitance	C_{res}	—	2000	—		
Turn-on time	t_{on}	—	0.6	1.2	$V_{cc}=300\text{V}$ $I_c=300\text{A}$ $V_{GE}=\pm 15\text{V}$ $R_g=6.8\text{ohm}$	μs
	t_r	—	0.2	0.6		
Turn-off time	t_{off}	—	0.6	1.0		
	t_f	—	0.2	0.35		
Diode forward on voltage	V_F	—	—	3.0	$I_F=300\text{A}$, $V_{GE}=0\text{V}$	V
Reverse recovery time	t_{rr}	—	—	0.3	$I_F=300\text{A}$	μs

● Thermal resistance characteristics

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	$R_{th(j-c)}$	—	—	0.11	IGBT	$^\circ\text{C/W}$
	$R_{th(j-c)}$	—	—	0.24	Diode	$^\circ\text{C/W}$
	$R_{th(c-f)}^*$	—	0.025	—	the base to cooling fin	$^\circ\text{C/W}$

*2 : This is the value which is defined mounting on the additional cooling fin with thermal compound